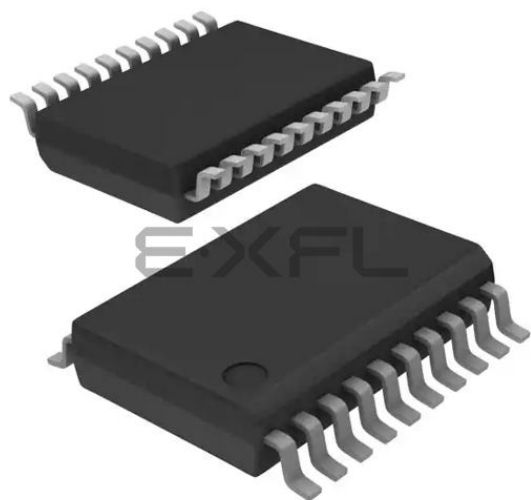




Welcome to E-XFL.COM

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	13
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 5.5V
Data Converters	A/D 4x8b
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c716-04-ss

PIC16C712/716

TABLE 1-1: PIC16C712/716 PINOUT DESCRIPTION

Pin Name	PIC16C712/716		Pin Type	Buffer Type	Description
	DIP, SOIC	SSOP			
MCLR/VPP MCLR VPP	4	4	I P	ST 	Master clear (Reset) input. This pin is an active low Reset to the device. Programming voltage input
OSC1/CLKIN OSC1 CLKIN	16	18	I I	ST CMOS	Oscillator crystal input or external clock source input. ST buffer when configured in RC mode. CMOS otherwise. External clock source input.
OSC2/CLKOUT OSC2 CLKOUT	15	17	O O	— —	Oscillator crystal output. Connects to crystal or resonator in crystal oscillator mode. In RC mode, OSC2 pin outputs CLKOUT which has 1/4 the frequency of OSC1, and denotes the instruction cycle rate.
RA0/AN0 RA0 AN0	17	19	I/O I	TTL Analog	PORTA is a bidirectional I/O port. Digital I/O Analog input 0
RA1/AN1 RA1 AN1	18	20	I/O I	TTL Analog	Digital I/O Analog input 1
RA2/AN2 RA2 AN2	1	1	I/O I	TTL Analog	Digital I/O Analog input 2
RA3/AN3/VREF RA3 AN3 VREF	2	2	I/O I I	TTL Analog Analog	Digital I/O Analog input 3 A/D Reference Voltage input.
RA4/T0CKI RA4 T0CKI	3	3	I/O I	ST/OD ST	Digital I/O. Open drain when configured as output. Timer0 external clock input

Legend: TTL = TTL-compatible input CMOS = CMOS compatible input or output
ST = Schmitt Trigger input with CMOS levels
OD = Open drain output
SM = SMBus compatible input. An external resistor is required if this pin is used as an output
NPU = N-channel pull-up PU = Weak internal pull-up
No-P diode = No P-diode to VDD AN = Analog input or output
I = input O = output
P = Power L = LCD Driver

PIC16C712/716

NOTES:

2.2.2.1 Status Register

The STATUS register, shown in Figure 2-4, contains the arithmetic status of the ALU, the Reset status and the bank select bits for data memory.

The STATUS register can be the destination for any instruction, as with any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the $\overline{TO}$ and $\overline{PD}$ bits are not writable. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

For example, CLRF STATUS will clear the upper-three bits and set the Z bit. This leaves the STATUS register as 000u u1uu (where u = unchanged).

It is recommended, therefore, that only BCF, BSF, SWAPF and MOVWF instructions are used to alter the STATUS register because these instructions do not affect the Z, C or DC bits from the STATUS register. For other instructions, not affecting any Status bits, see the "Instruction Set Summary."

Note 1: These devices do not use bits IRP and RP1 (STATUS<7:6>). Maintain these bits clear to ensure upward compatibility with future products.

2: The C and DC bits operate as a borrow and digit borrow bit, respectively, in subtraction. See the SUBLW and SUBWF instructions for examples.

FIGURE 2-4: STATUS REGISTER (ADDRESS 03h, 83h)

R/W-0	R/W-0	R/W-0	R-1	R-1	R/W-x	R/W-x	R/W-x
IRP	RP1	RP0	$\overline{TO}$	$\overline{PD}$	Z	DC	C
bit7							bit0

R = Readable bit
W = Writable bit
U = Unimplemented bit, read as '0'
-n = Value at POR Reset

bit 7: **IRP:** Register Bank Select bit (used for indirect addressing)
1 = Bank 2, 3 (100h-1FFh) – not implemented, maintain clear
0 = Bank 0, 1 (00h-FFh) – not implemented, maintain clear

bit 6-5: **RP1:RP0:** Register Bank Select bits (used for direct addressing)
01 = Bank 1 (80h-FFh)
00 = Bank 0 (00h-7Fh)
Each bank is 128 bytes
Note: RP1 = not implemented, maintain clear

bit 4: **$\overline{TO}$:** Time-out bit
1 = After power-up, CLRWD $\overline{T}$ instruction, or SLEEP instruction
0 = A WDT Time-out occurred

bit 3: **$\overline{PD}$:** Power-down bit
1 = After power-up or by the CLRWD $\overline{T}$ instruction
0 = By execution of the SLEEP instruction

bit 2: **Z:** Zero bit
1 = The result of an arithmetic or logic operation is zero
0 = The result of an arithmetic or logic operation is not zero

bit 1: **DC:** Digit carry/borrow bit (ADDWF, ADDLW, SUBLW, SUBWF instructions) (for borrow the polarity is reversed)
1 = A carry-out from the 4th low order bit of the result occurred
0 = No carry-out from the 4th low order bit of the result

bit 0: **C:** Carry/borrow bit (ADDWF, ADDLW, SUBLW, SUBWF instructions)
1 = A carry-out from the most significant bit of the result occurred
0 = No carry-out from the most significant bit of the result occurred

Note: For borrow the polarity is reversed. A subtraction is executed by adding the two's complement of the second operand. For rotate (RRF, RLF) instructions, this bit is loaded with either the high or low order bit of the source register.

PIC16C712/716

TABLE 3-4: SUMMARY OF REGISTERS ASSOCIATED WITH PORTB

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
06h	PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	xxxx xxxx	uuuu uuuu
86h	TRISB	PORTB Data Direction Register								1111 1111	1111 1111
81h	OPTION_REG	$\overline{\text{RBPU}}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111

Legend: x = unknown, u = unchanged. Shaded cells are not used by PORTB.

PIC16C712/716

NOTES:

7.0 CAPTURE/COMPARE/PWM (CCP) MODULE(S)

Each CCP (Capture/Compare/PWM) module contains a 16-bit register, which can operate as a 16-bit capture register, as a 16-bit compare register or as a PWM master/slave Duty Cycle register. Table 7-1 shows the timer resources of the CCP module modes.

Capture/Compare/PWM Register 1 (CCPR1) is comprised of two 8-bit registers: CCPR1L (low byte) and CCPR1H (high byte). The CCP1CON register controls the operation of CCP1. All are readable and writable.

Additional information on the CCP module is available in the PIC® Mid-Range Reference Manual, (DS33023).

TABLE 7-1: CCP MODE – TIMER RESOURCE

CCP Mode	Timer Resource
Capture	Timer1
Compare	Timer1
PWM	Timer2

FIGURE 7-1: CCP1CON REGISTER (ADDRESS 17h)

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0
bit7							bit0

R = Readable bit
W = Writable bit
U = Unimplemented bit, read as '0'
-n = Value at POR Reset

bit 7-6: **Unimplemented:** Read as '0'

bit 5-4: **DC1B1:DC1B0:** PWM Least Significant bits
Capture Mode: Unused
Compare Mode: Unused
PWM Mode: These bits are the two LSbs of the PWM duty cycle. The eight MSbs are found in CCPR1L.

bit 3-0: **CCP1M3:CCP1M0:** CCP1 Mode Select bits
0000 = Capture/Compare/PWM off (resets CCP1 module)
0100 = Capture mode, every falling edge
0101 = Capture mode, every rising edge
0110 = Capture mode, every 4th rising edge
0111 = Capture mode, every 16th rising edge
1000 = Compare mode, set output on match (CCP1IF bit is set)
1001 = Compare mode, clear output on match (CCP1IF bit is set)
1010 = Compare mode, generate software interrupt on match (CCP1IF bit is set, CCP1 pin is unaffected)
1011 = Compare mode, trigger special event (CCP1IF bit is set; CCP1 resets TMR1 and starts an A/D conversion (if A/D module is enabled))
11xx = PWM mode

FIGURE 7-2: TRISCCP REGISTER (ADDRESS 87H)

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	—	—	—	TCCP	—	TT1CK
bit7							bit0

R = Readable bit
W = Writable bit
U = Unimplemented bit, read as '0'
-n = Value at POR Reset

bit 7-3: **Reserved bits; Do Not Use**

bit 2: **TCCP – Tri-state control bit for CCP**
0 = Output pin driven
1 = Output pin tristated

bit 1: **Reserved bit; Do Not Use**

bit 0: **TT1CK – Tri-state control bit for T1CKI pin**
0 = T1CKI pin is an output
1 = T1CKI pin is an input

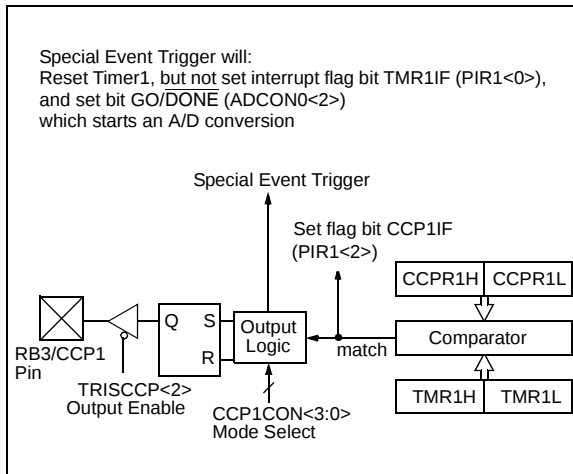
7.2 Compare Mode

In Compare mode, the 16-bit CCPR1 register value is constantly compared against the TMR1 register pair value. When a match occurs, the RB3/CCP1 pin is either:

- driven High
- driven Low
- remains Unchanged

The action on the pin is based on the value of control bits CCP1M3:CCP1M0 (CCP1CON<3:0>). At the same time, interrupt flag bit CCP1IF is set.

FIGURE 7-4: COMPARE MODE OPERATION BLOCK DIAGRAM



7.2.1 CCP PIN CONFIGURATION

The user must configure the RB3/CCP1 pin as the CCP output by clearing the TRISCCP<2> bit.

Note: Clearing the CCP1CON register will force the RB3/CCP1 compare output latch to the default low level. This is neither the PORTB I/O data latch nor the DATA CCP latch.

7.2.2 TIMER1 MODE SELECTION

Timer1 must be running in Timer mode or Synchronized Counter mode if the CCP module is using the compare feature. In Asynchronous Counter mode, the compare operation may not work.

7.2.3 SOFTWARE INTERRUPT MODE

When generate software interrupt is chosen the CCP1 pin is not affected. Only a CCP interrupt is generated (if enabled).

7.2.4 SPECIAL EVENT TRIGGER

In this mode, an internal hardware trigger is generated which may be used to initiate an action.

The Special Event Trigger output of CCP1 resets the TMR1 register pair. This allows the CCPR1 register to effectively be a 16-bit programmable period register for Timer1.

The Special Event Trigger output of CCP1 also starts an A/D conversion (if the A/D module is enabled).

Note: The Special Event Trigger from the CCP1 module will not set interrupt flag bit TMR1IF (PIR1<0>).

TABLE 7-2: REGISTERS ASSOCIATED WITH CAPTURE, COMPARE, AND TIMER1

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
07h	DATA CCP	—	—	—	—	—	DCCP	—	DT1CK	xxxx xxxx	xxxx xuxu
0Bh,8Bh	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	—	ADIF	—	—	—	CCP1IF	TMR2IF	TMR1IF	-0-- -000	-0-- -000
0Eh	TMR1L	Holding Register for the Least Significant Byte of the 16-bit TMR1 Register								xxxx xxxx	uuuu uuuu
0Fh	TMR1H	Holding Register for the Most Significant Byte of the 16-bit TMR1 Register								xxxx xxxx	uuuu uuuu
10h	T1CON	—	—	T1CKPS1	T1CKPS0	T1OSCEN	T1SYN	TMR1CS	TMR1ON	--00 0000	--uu uuuu
15h	CCPR1L	Capture/Compare/PWM Register 1 (LSB)								xxxx xxxx	uuuu uuuu
16h	CCPR1H	Capture/Compare/PWM Register 1 (MSB)								xxxx xxxx	uuuu uuuu
17h	CCP1CON	—	—	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	--00 0000	--00 0000
87h	TRISCCP	—	—	—	—	—	TCCP	—	TT1CK	xxxx x1x1	xxxx x1x1
8Ch	PIE1	—	ADIE	—	—	—	CCP1IE	TMR2IE	TMR1IE	-0-- -000	-0-- -000

Legend: x = unknown, u = unchanged, — = unimplemented read as '0'. Shaded cells are not used by Capture and Timer1.

The ADRES register contains the result of the A/D conversion. When the A/D conversion is complete, the result is loaded into the ADRES register, the $\overline{\text{GO/DONE}}$ bit (ADCON0<2>) is cleared and the A/D Interrupt Flag bit ADIF is set. The block diagram of the A/D module is shown in Figure 8-3.

The value that is in the ADRES register is not modified for a Power-on Reset. The ADRES register will contain unknown data after a Power-on Reset.

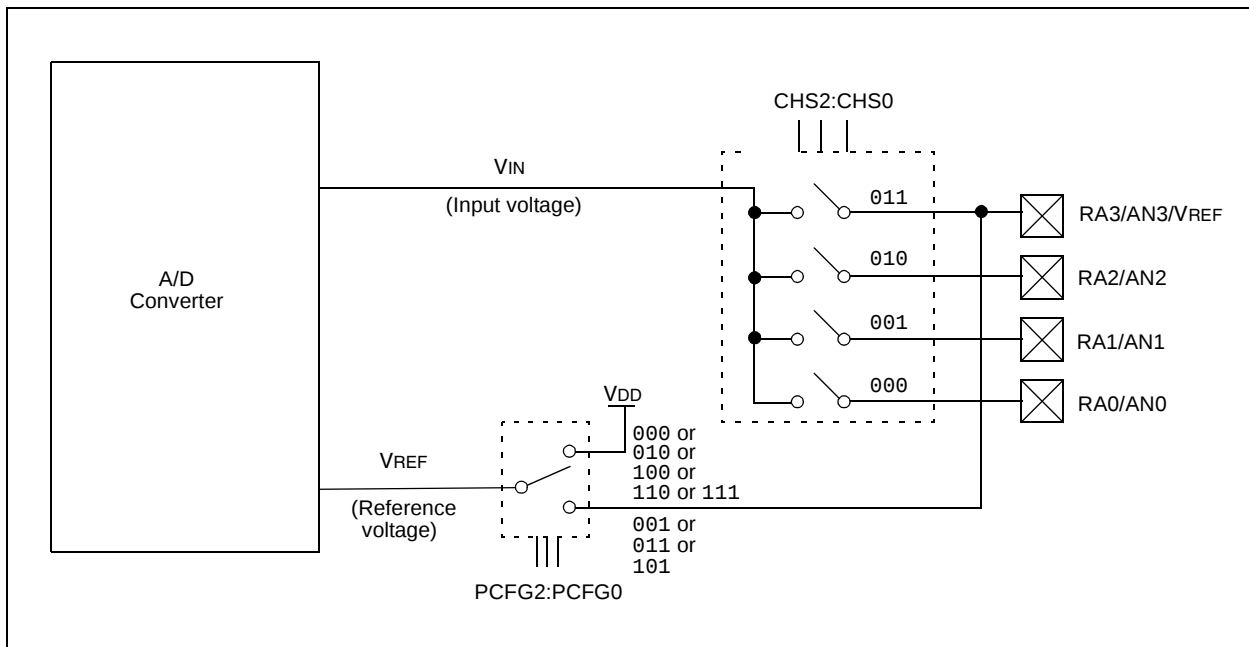
After the A/D module has been configured as desired, the selected channel must be acquired before the conversion is started. The analog input channels must have their corresponding TRIS bits selected as an input. To determine acquisition time, see **Section 8.1 “A/D Acquisition Requirements”**. After this acquisition time has elapsed, the A/D conversion can be started. The following steps should be followed for doing an A/D conversion:

1. Configure the A/D module:
 - Configure analog pins/voltage reference/ and digital I/O (ADCON1)
 - Select A/D input channel (ADCON0)
 - Select A/D conversion clock (ADCON0)
 - Turn on A/D module (ADCON0)
2. Configure A/D interrupt (if desired):
 - Clear ADIF bit
 - Set ADIE bit
 - Set GIE bit
3. Wait the required acquisition time.
4. Start conversion:
 - Set $\overline{\text{GO/DONE}}$ bit (ADCON0)
5. Wait for A/D conversion to complete, by either:
 - Polling for the $\overline{\text{GO/DONE}}$ bit to be cleared

OR

 - Waiting for the A/D interrupt
6. Read A/D Result register (ADRES), clear bit ADIF if required.
7. For the next conversion, go to step 1 or step 2 as required. The A/D conversion time per bit is defined as T_{AD} . A minimum wait of $2T_{AD}$ is required before next acquisition starts.

FIGURE 8-3: A/D BLOCK DIAGRAM



9.2 Oscillator Configurations

9.2.1 OSCILLATOR TYPES

The PIC16CXXX can be operated in four different Oscillator modes. The user can program two Configuration bits (FOSC1 and FOSC0) to select one of these four modes:

- LP Low-Power Crystal
- XT Crystal/Resonator
- HS High-Speed Crystal/Resonator
- RC Resistor/Capacitor

9.2.2 CRYSTAL OSCILLATOR/CERAMIC RESONATORS

In XT, LP or HS modes, a crystal or ceramic resonator is connected to the OSC1/CLKIN and OSC2/CLKOUT pins to establish oscillation (Figure 9-2). The PIC16CXXX oscillator design requires the use of a parallel cut crystal. Use of a series cut crystal may give a frequency out of the crystal manufacturers specifications. When in XT, LP or HS modes, the device can have an external clock source to drive the OSC1/CLKIN pin (Figure 9-3).

FIGURE 9-2: CRYSTAL/CERAMIC RESONATOR OPERATION (HS, XT OR LP OSC CONFIGURATION)

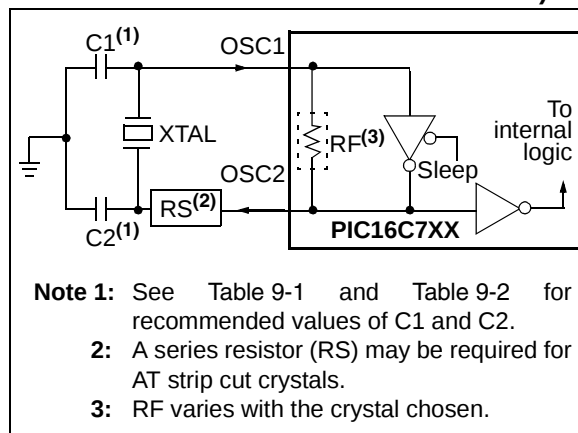


FIGURE 9-3: EXTERNAL CLOCK INPUT OPERATION (HS, XT OR LP OSC CONFIGURATION)

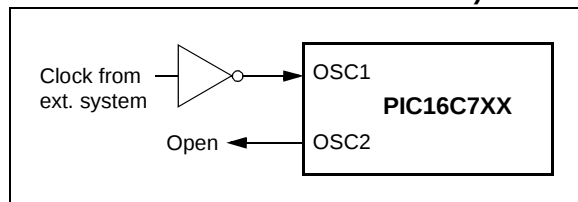


TABLE 9-1: CERAMIC RESONATORS

Ranges Tested:			
Mode	Freq	OSC1	OSC2
XT	455 kHz	68-100 pF	68-100 pF
	2.0 MHz	15-68 pF	15-68 pF
	4.0 MHz	15-68 pF	15-68 pF
HS	8.0 MHz	10-68 pF	10-68 pF
	16.0 MHz	10-22 pF	10-22 pF
These values are for design guidance only. See notes at bottom of page.			

TABLE 9-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR

Osc Type	Crystal Freq	Cap. Range C1	Cap. Range C2
LP	32 kHz	33 pF	33 pF
	200 kHz	15 pF	15 pF
XT	200 kHz	47-68 pF	47-68 pF
	1 MHz	15 pF	15 pF
	4 MHz	15 pF	15 pF
HS	4 MHz	15 pF	15 pF
	8 MHz	15-33 pF	15-33 pF
	20 MHz	15-33 pF	15-33 pF
These values are for design guidance only. See notes at bottom of page.			

- Note 1:** Recommended values of C1 and C2 are identical to the ranges tested (Table 9-1).
- 2:** Higher capacitance increases the stability of the oscillator, but also increases the start-up time.
- 3:** Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
- 4:** Rs may be required in HS mode, as well as XT mode to avoid overdriving crystals with low drive level specification.

TABLE 9-6: INITIALIZATION CONDITIONS FOR ALL REGISTERS OF THE PIC16C712/716

Register	Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset	Wake-up via WDT or Interrupt
W	xxxx xxxx	uuuu uuuu	uuuu uuuu
INDF	N/A	N/A	N/A
TMR0	xxxx xxxx	uuuu uuuu	uuuu uuuu
PCL	0000h	0000h	PC + 1 ⁽²⁾
STATUS	0001 1xxx	000q quuu ⁽³⁾	uuuq quuu ⁽³⁾
FSR	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTA ⁽⁴⁾	--0x 0000	--xx xxxx	--xu uuuu
PORTB ⁽⁵⁾	xxxx xxxx	uuuu uuuu	uuuu uuuu
DATA CCP	---- -x-x	---- -u-u	---- -u-u
PCLATH	---0 0000	---0 0000	---u uuuu
INTCON	0000 -00x	0000 -00u	uuuu -uuu ⁽¹⁾
PIR1	---- 0000	---- 0000	---- uuuu ⁽¹⁾
	-0-- 0000	-0-- 0000	-u-- uuuu ⁽¹⁾
TMR1L	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR1H	xxxx xxxx	uuuu uuuu	uuuu uuuu
T1CON	--00 0000	--uu uuuu	--uu uuuu
TMR2	0000 0000	0000 0000	uuuu uuuu
T2CON	-000 0000	-000 0000	-uuu uuuu
CCPR1L	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR1H	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP1CON	--00 0000	--00 0000	--uu uuuu
ADRES	xxxx xxxx	uuuu uuuu	uuuu uuuu
ADCON0	0000 00-0	0000 00-0	uuuu uu-u
OPTION_REG	1111 1111	1111 1111	uuuu uuuu
TRISA	--11 1111	--11 1111	--uu uuuu
TRISB	1111 1111	1111 1111	uuuu uuuu
TRIS CCP	xxxx x1x1	xxxx x1x1	xxxx xuxu
PIE1	---- 0000	---- 0000	---- uuuu
	-0-- 0000	-0-- 0000	-u-- uuuu
PCON	---- --0q	---- --uq	---- --uq
PR2	1111 1111	1111 1111	1111 1111
ADCON1	---- -000	---- -000	---- -uuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition

Note 1: One or more bits in INTCON and/or PIR1 will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

3: See Table 9-5 for Reset value for specific condition.

4: On any device Reset, these pins are configured as inputs.

5: This is the value that will be in the port output latch.

11.0 DEVELOPMENT SUPPORT

The PIC® microcontrollers are supported with a full range of hardware and software development tools:

- Integrated Development Environment
 - MPLAB® IDE Software
- Assemblers/Compilers/Linkers
 - MPASM™ Assembler
 - MPLAB C18 and MPLAB C30 C Compilers
 - MPLINK™ Object Linker/
MPLIB™ Object Librarian
 - MPLAB ASM30 Assembler/Linker/Library
- Simulators
 - MPLAB SIM Software Simulator
- Emulators
 - MPLAB ICE 2000 In-Circuit Emulator
 - MPLAB ICE 4000 In-Circuit Emulator
- In-Circuit Debugger
 - MPLAB ICD 2
- Device Programmers
 - PICSTART® Plus Development Programmer
 - MPLAB PM3 Device Programmer
- Low-Cost Demonstration and Development Boards and Evaluation Kits

11.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8/16-bit microcontroller market. The MPLAB IDE is a Windows® operating system-based application that contains:

- A single graphical interface to all debugging tools
 - Simulator
 - Programmer (sold separately)
 - Emulator (sold separately)
 - In-Circuit Debugger (sold separately)
- A full-featured editor with color-coded context
- A multiple project manager
- Customizable data windows with direct edit of contents
- High-level source code debugging
- Visual device initializer for easy register initialization
- Mouse over variable inspection
- Drag and drop variables from source to watch windows
- Extensive on-line help
- Integration of select third party tools, such as HI-TECH Software C Compilers and IAR C Compilers

The MPLAB IDE allows you to:

- Edit your source files (either assembly or C)
- One touch assemble (or compile) and download to PIC MCU emulator and simulator tools (automatically updates all project information)
- Debug using:
 - Source files (assembly or C)
 - Mixed assembly and C
 - Machine code

MPLAB IDE supports multiple debugging tools in a single development paradigm, from the cost-effective simulators, through low-cost in-circuit debuggers, to full-featured emulators. This eliminates the learning curve when upgrading to tools with increased flexibility and power.

PIC16C712/716

FIGURE 12-1: PIC16C712/716 VOLTAGE-FREQUENCY GRAPH, $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$

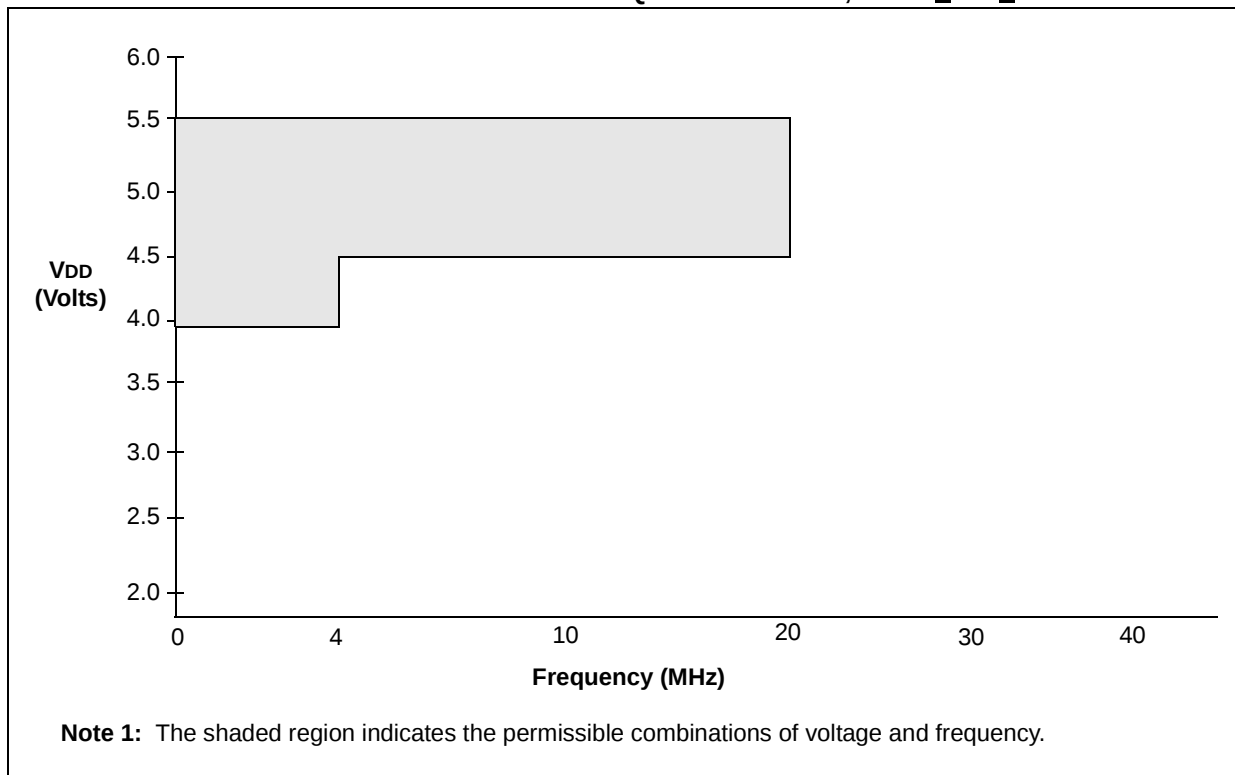
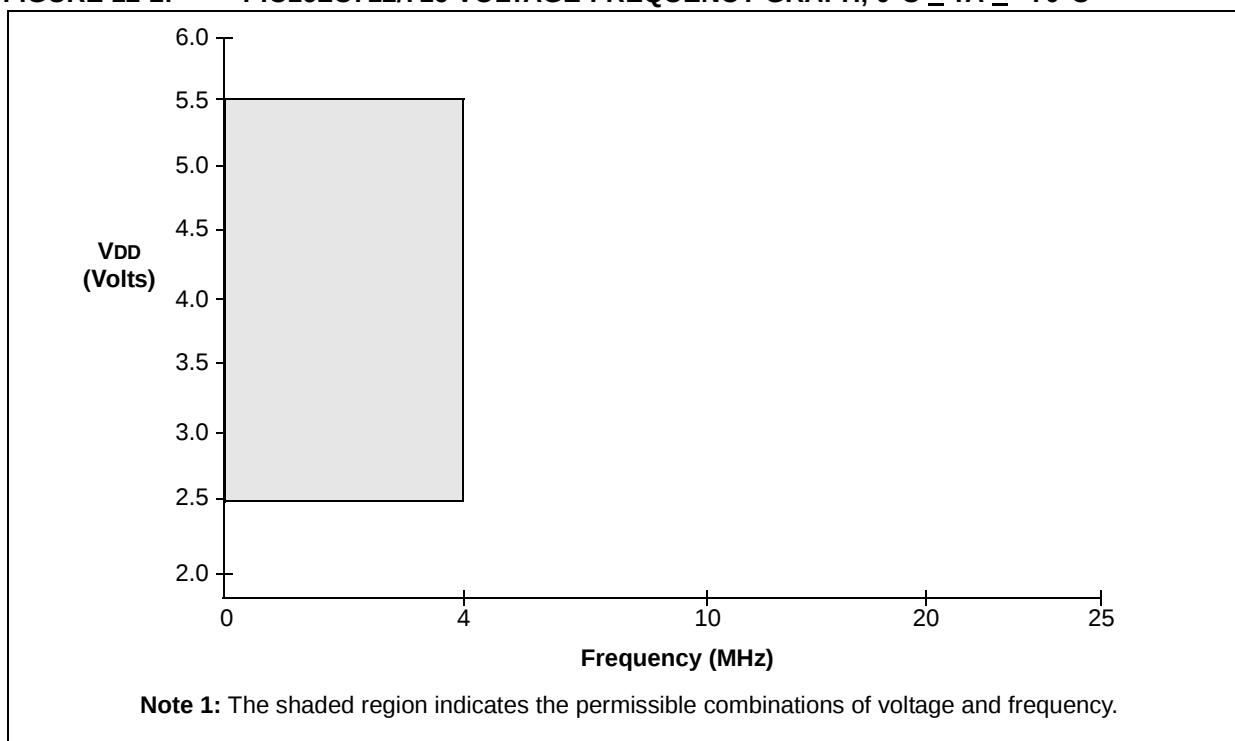


FIGURE 12-2: PIC16LC712/716 VOLTAGE-FREQUENCY GRAPH, $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$



12.3 DC Characteristics: PIC16C712/716-04 (Commercial, Industrial, Extended) PIC16C712/716-20 (Commercial, Industrial, Extended) PIC16LC712/716-04 (Commercial, Industrial)

Standard Operating Conditions (unless otherwise stated) Operating temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended Operating voltage V_{DD} range as described in DC spec Section 12.1 “DC Characteristics: PIC16C712/716-04 (Commercial, Industrial, Extended) PIC16C712/716-20 (Commercial, Industrial, Extended)” and Section 12.2 “DC Characteristics: PIC16LC712/716-04 (Commercial, Industrial)”							
Param No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
D030 D030A D031 D032 D033	V_{IL}	Input Low Voltage I/O ports with TTL buffer with Schmitt Trigger buffer $\overline{\text{MCLR}}$, OSC1 (in RC mode) OSC1 (in XT, HS and LP modes)	V_{SS} V_{SS} V_{SS} V_{SS} V_{SS}	— — — — —	0.8V 0.15V _{DD} 0.2V _{DD} 0.2V _{DD} 0.3V _{DD}	V V V V V	$4.5\text{V} \leq V_{DD} \leq 5.5\text{V}$ otherwise (Note 1)
D040 D040A D041 D042 D042A D043	V_{IH}	Input High Voltage I/O ports with TTL buffer with Schmitt Trigger buffer $\overline{\text{MCLR}}$ OSC1 (XT, HS and LP modes) OSC1 (in RC mode)	2.0 0.25V _{DD} + 0.8V 0.8V _{DD} 0.8V _{DD} 0.7V _{DD} 0.9V _{DD}	— — — — — —	V _{DD} V _{DD} V _{DD} V _{DD} V _{DD} V _{DD}	V V V V V V	$4.5\text{V} \leq V_{DD} \leq 5.5\text{V}$ otherwise For entire V _{DD} range (Note 1)
D060 D061 D063	I_{IL}	Input Leakage Current (Notes 2, 3) I/O ports $\overline{\text{MCLR}}$, RA4/T0CKI OSC1	— — —	— — —	±1 ±5 ±5	μA μA μA	$V_{SS} \leq V_{PIN} \leq V_{DD}$, Pin at high-impedance $V_{SS} \leq V_{PIN} \leq V_{DD}$ $V_{SS} \leq V_{PIN} \leq V_{DD}$, XT, HS and LP osc modes
D070	IPURB	PORTB weak pull-up current	50	250	400	μA	$V_{DD} = 5\text{V}$, $V_{PIN} = V_{SS}$

* These parameters are characterized but not tested.

† Data in “Typ” column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC Oscillator mode, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC MCU be driven with external clock in RC mode.

2: The leakage current on the $\overline{\text{MCLR}}$ /V_{PP} pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

12.4 AC (Timing) Characteristics

12.4.1 TIMING PARAMETER SYMBOLOGY

The timing parameter symbols have been created using one of the following formats:

1. TppS2ppS
2. TppS

T			
F	Frequency	T	Time

Lowercase letters (pp) and their meanings:

pp			
cc	CCP1	osc	OSC1
ck	CLKOUT	rd	$\overline{RD}$
cs	$\overline{CS}$	rw	$\overline{RD}$ or $\overline{WR}$
di	SDI	sc	SCK
do	SDO	ss	$\overline{SS}$
dt	Data in	t0	T0CKI
io	I/O port	t1	T1CKI
mc	$\overline{MCLR}$	wr	$\overline{WR}$

Uppercase letters and their meanings:

S			
F	Fall	P	Period
H	High	R	Rise
I	Invalid (High-impedance)	V	Valid
L	Low	Z	High-impedance

12.4.3 TIMING DIAGRAMS AND SPECIFICATIONS

FIGURE 12-4: EXTERNAL CLOCK TIMING

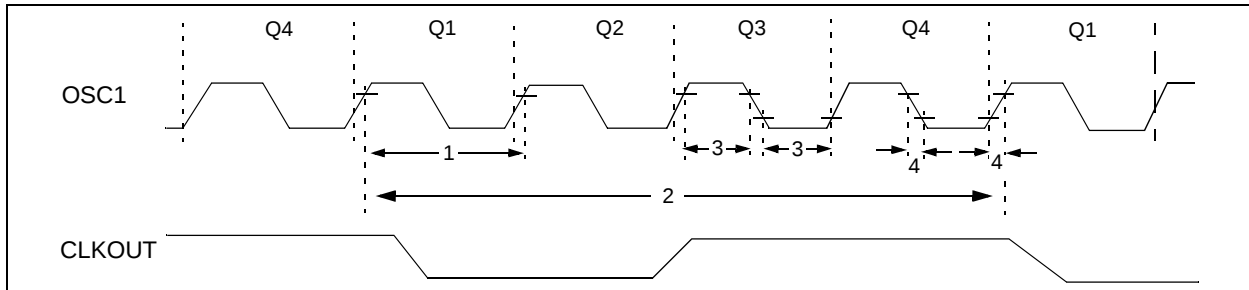


TABLE 12-2: EXTERNAL CLOCK TIMING REQUIREMENTS

Param No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
1A	Fosc	External CLKIN Frequency (Note 1)	DC	—	4	MHz	RC and XT osc modes
			DC	—	4	MHz	HS osc mode (-04)
			DC	—	20	MHz	HS osc mode (-20)
			DC	—	200	kHz	LP osc mode
		Oscillator Frequency (Note 1)	DC	—	4	MHz	RC osc mode
			0.1	—	4	MHz	XT osc mode
			4	—	20	MHz	HS osc mode
			5	—	200	kHz	LP osc mode
1	Tosc	External CLKIN Period (Note 1)	250	—	—	ns	RC and XT osc modes
			250	—	—	ns	HS osc mode (-04)
			50	—	—	ns	HS osc mode (-20)
			5	—	—	μs	LP osc mode
		Oscillator Period (Note 1)	250	—	—	ns	RC osc mode
			250	—	10,000	ns	XT osc mode
			250	—	250	ns	HS osc mode (-04)
			50	—	250	ns	HS osc mode (-20)
			5	—	—	μs	LP osc mode
2	Tcy	Instruction Cycle Time (Note 1)	200	—	DC	ns	Tcy = 4/Fosc
3*	TosL, TosH	External Clock in (OSC1) High or Low Time	100	—	—	ns	XT oscillator
			2.5	—	—	μs	LP oscillator
			15	—	—	ns	HS oscillator
4*	TosR, TosF	External Clock in (OSC1) Rise or Fall Time	—	—	25	ns	XT oscillator
			—	—	50	ns	LP oscillator
			—	—	15	ns	HS oscillator

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note1: Instruction cycle period (Tcy) equals four times the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin.

When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

FIGURE 12-9: CAPTURE/COMPARE/PWM TIMINGS

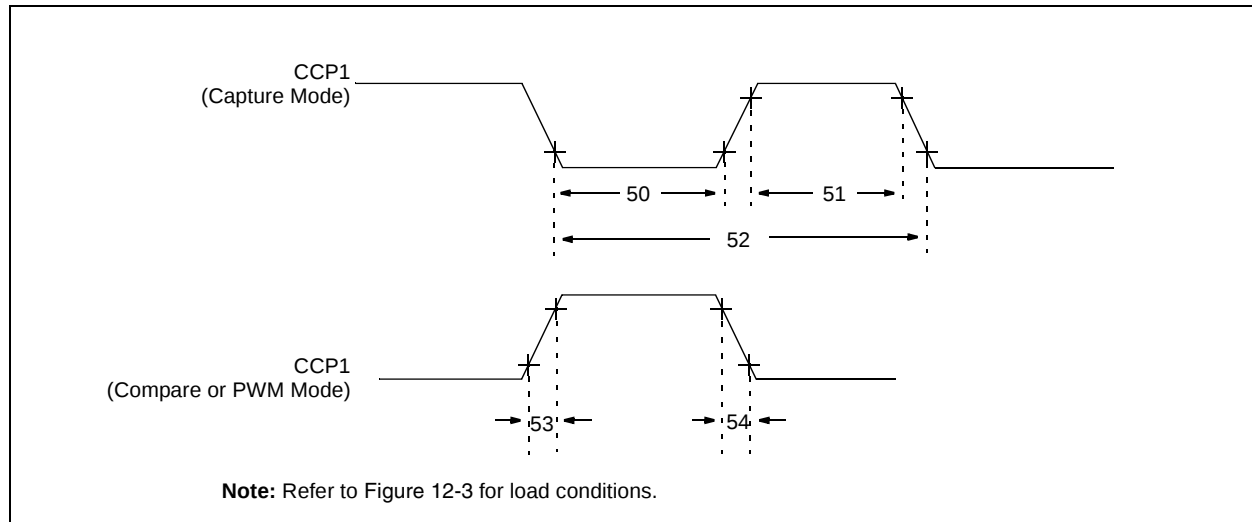


TABLE 12-6: CAPTURE/COMPARE/PWM REQUIREMENTS

Param No.	Sym.	Characteristic		Min	Typ†	Max	Units	Conditions
50*	TccL	CCP1 input low time	No Prescaler	$0.5T_{CY} + 20$	—	—	ns	
			With Prescaler					
			Standard	10	—	—	ns	
			Extended (LC)	20	—	—	ns	
51*	TccH	CCP1 input high time	No Prescaler	$0.5T_{CY} + 20$	—	—	ns	
			With Prescaler					
			Standard	10	—	—	ns	
			Extended (LC)	20	—	—	ns	
52*	TccP	CCP1 input period		$\frac{3T_{CY} + 40}{N}$	—	—	ns	N = prescale value (1, 4, or 16)
53*	TccR	CCP1 output rise time	Standard	—	10	25	ns	
			Extended (LC)	—	25	45	ns	
54*	TccF	CCP1 output fall time	Standard	—	10	25	ns	
			Extended (LC)	—	25	45	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C712/716

TABLE 12-7: A/D CONVERTER CHARACTERISTICS:
PIC16C712/716-04 (COMMERCIAL, INDUSTRIAL, EXTENDED)
PIC16C712/716-20 (COMMERCIAL, INDUSTRIAL, EXTENDED)
PIC16LC712/716-04 (COMMERCIAL, INDUSTRIAL)

Param No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
A01	NR	Resolution	—	—	8-bits	bit	$V_{REF} = V_{DD} = 5.12V$, $V_{SS} \leq V_{AIN} \leq V_{REF}$
A02	EABS	Total Absolute error	—	—	$< \pm 1$	LSb	$V_{REF} = V_{DD} = 5.12V$, $V_{SS} \leq V_{AIN} \leq V_{REF}$
A03	EIL	Integral linearity error	—	—	$< \pm 1$	LSb	$V_{REF} = V_{DD} = 5.12V$, $V_{SS} \leq V_{AIN} \leq V_{REF}$
A04	EDL	Differential linearity error	—	—	$< \pm 1$	LSb	$V_{REF} = V_{DD} = 5.12V$, $V_{SS} \leq V_{AIN} \leq V_{REF}$
A05	EFS	Full scale error	—	—	$< \pm 1$	LSb	$V_{REF} = V_{DD} = 5.12V$, $V_{SS} \leq V_{AIN} \leq V_{REF}$
A06	E _{OFF}	Offset error	—	—	$< \pm 1$	LSb	$V_{REF} = V_{DD} = 5.12V$, $V_{SS} \leq V_{AIN} \leq V_{REF}$
A10	—	Monotonicity	—	guaranteed (Note 3)	—	—	$V_{SS} \leq V_{AIN} \leq V_{REF}$
A20	V _{REF}	Reference voltage	2.5V	—	$V_{DD} + 0.3$	V	
A25	V _{AIN}	Analog input voltage	$V_{SS} - 0.3$	—	$V_{REF} + 0.3$	V	
A30	Z _{AIN}	Recommended impedance of analog voltage source	—	—	10.0	k Ω	
A40	I _{AD}	A/D conversion current (V_{DD})	Standard	—	180	—	μA Average current consumption when A/D is on. (Note 1)
			Extended (LC)	—	90	—	
A50	I _{REF}	V _{REF} input current (Note 2)	10	—	1000	μA	During V _{AIN} acquisition. Based on differential of V _{HOLD} to V _{AIN} to charge CHOLD, see Section 9.1 "Configuration Bits". During A/D Conversion cycle
			—	—	10	μA	

2: * These parameters are characterized but not tested.

3: † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: When A/D is off, it will not consume any current other than minor leakage current. The power-down current spec includes any such leakage from the A/D module.

2: V_{REF} current is from RA3 pin or V_{DD} pin, whichever is selected as reference input.

3: The A/D conversion result never decreases with an increase in the Input Voltage, and has no missing codes.

PIC16C712/716

Interrupt Sources.....	51, 61	XT	53, 58
A/D Conversion Complete	47	Oscillator, Timer1.....	31, 34
Block Diagram.....	61	Oscillator, WDT.....	63
Capture Complete (CCP).....	40	P	
Compare Complete (CCP).....	41	Packaging	89
Interrupt-on-Change (RB7:RB4)	24	Details.....	90
RB0/INT Pin, External.....	62	Paging, Program Memory.....	9, 19
TMR0 Overflow	30, 62	PCON Register	18, 58
TMR1 Overflow	31, 34	BOR Bit.....	18
TMR2 to PR2 Match	37	POR Bit.....	18
TMR2 to PR2 Match (PWM)	36, 42	PICSTART Plus Development Programmer	72
Interrupts, Context Saving During	62	PIE1 Register.....	12, 16
Interrupts, Enable Bits		ADIE Bit	16
A/D Converter Enable (ADIE Bit)	16	CCP1IE Bit	16
CCP1 Enable (CCP1IE Bit).....	16, 40	TMR1IE Bit	16
Global Interrupt Enable (GIE Bit)	15, 61	TMR2IE Bit	16
Interrupt-on-Change (RB7:RB4) Enable		Pin Functions	
(RBIE Bit).....	15, 62	MCLR/VPP	6
Peripheral Interrupt Enable (PEIE Bit)	15	RA0/AN0.....	6
RB0/INT Enable (INTE Bit)	15	RA1/AN1.....	6
TMR0 Overflow Enable (T0IE Bit).....	15	RA2/AN2.....	6
TMR1 Overflow Enable (TMR1IE Bit)	16	RA3/AN3/VREF.....	6
TMR2 to PR2 Match Enable (TMR2IE Bit)	16	RA4/T0CKI	6
Interrupts, Flag Bits		RB0/INT	7
A/D Converter Flag (ADIF Bit)	17, 47	RB1.....	7
CCP1 Flag (CCP1IF Bit)	17, 40, 41	RB2.....	7
Interrupt-on-Change (RB7:RB4) Flag		RB3.....	7
(RBIF Bit)	15, 24, 62	RB4.....	7
RB0/INT Flag (INTF Bit).....	15	RB5.....	7
TMR0 Overflow Flag (T0IF Bit)	15, 62	RB6.....	7
TMR1 Overflow Flag (TMR1IF Bit)	17	RB7.....	7
TMR2 to PR2 Match Flag (TMR2IF Bit).....	17	VDD	7
M		Vss	7
Master Clear (MCLR)		Pinout Descriptions	
MCLR Reset, Normal Operation	54, 58, 59	PIC16C712/716 Pinout Description	6
MCLR Reset, Sleep	59	PIR1 Register	11, 17
MCLR Reset, Sleep	54, 58	ADIF Bit	17
Memory Organization		CCP1IF Bit.....	17
Data Memory	10	TMR1IF Bit.....	17
Program Memory	9	TMR2IF Bit	17
Microchip Internet Web Site	101	Pointer, FSR	20
MPLAB ASM30 Assembler, Linker, Librarian	70	POR. See Power-on Reset	
MPLAB ICD 2 In-Circuit Debugger.....	71	PORTA	
MPLAB ICE 2000 High-Performance Universal		Initialization.....	21
In-Circuit Emulator	71	PORTA Register	11, 21
MPLAB ICE 4000 High-Performance Universal		RA3:RA0 Port Pins	21
In-Circuit Emulator	71	RA4/T0CKI Pin	22
MPLAB Integrated Development Environment Software ...	69	TRISA Register.....	12, 21
MPLAB PM3 Device Programmer.....	71	PORTB	
MPLINK Object Linker/MPLIB Object Librarian	70	Block Diagram of RB1/T1OSO/T1CKI Pin.....	24
O		Block Diagram of RB2/T10SI Pin.....	25
OPCODE Field Descriptions	67	Block Diagram of RB3/CCP1 Pin	25
OPTION_REG Register	12, 14	Initialization.....	23
INTEDG Bit	14	PORTB Register	11, 23
PS2:PS0 Bits	14, 29	Pull-up Enable (RBPU Bit).....	14
PSA Bit.....	14, 29	RB0/INT Edge Select (INTEDG Bit)	14
RBPU Bit.....	14	RB0/INT Pin, External.....	62
T0CS Bit.....	14, 29	RB3:RB0 Port Pins	23
T0SE Bit.....	14, 29	RB7:RB4 Interrupt-on-Change	62
Oscillator Configuration.....	51, 53	RB7:RB4 Interrupt-on-Change Enable (RBIE Bit)	15, 62
HS	53, 58	RB7:RB4 Interrupt-on-Change Flag	
LP.....	53, 58	(RBIF Bit).....	15, 24, 62
RC.....	53, 54, 58	RB7:RB4 Port Pins	26
Selection (FOSC1:FOSC0 Bits).....	52	TRISB Register.....	12, 23

PORTC	
TRISC Register	12
Postscaler, Timer2	
Select (TOUTPS3:TOUTPS0 Bits)	36
Postscaler, WDT	29
Assignment (PSA Bit)	14, 29
Block Diagram	30
Rate Select (PS2:PS0 Bits)	14, 29
Switching Between Timer0 and WDT	30
Power-down Mode. See Sleep	
Power-on Reset (POR)	51, 54, 55, 58, 59
Oscillator Start-up Timer (OST)	51, 55
POR Status (POR Bit)	18
Power Control (PCON) Register	58
Power-down (PD Bit)	13, 54
Power-on Reset Circuit, External	55
Power-up Timer (PWRT)	51, 55
PWRT Enable (PWRTE Bit)	52
Time-out (TO Bit)	13, 54
Time-out Sequence	57
Time-out Sequence on Power-up	60
Timing Diagram	83
Prescaler, Capture	40
Prescaler, Timer0	29
Assignment (PSA Bit)	14, 29
Block Diagram	30
Rate Select (PS2:PS0 Bits)	14, 29
Switching Between Timer0 and WDT	30
Prescaler, Timer1	32
Select (T1CKPS1:T1CKPS0 Bits)	31
Prescaler, Timer2	42
Select (T2CKPS1:T2CKPS0 Bits)	36
Product Identification System	103
Program Counter	
PCL Register	11, 19
PCLATH Register	11, 19, 62
Reset Conditions	58
Program Memory	9
Interrupt Vector	9
Paging	9, 19
Program Memory Map	9
Reset Vector	9
Program Verification	65
Programming, Device Instructions	67
PWM (CCP Module)	42
Block Diagram	42
CCPR1H:CCPR1L Registers	42
Duty Cycle	42
Example Frequencies/Resolutions	43
Output Diagram	42
Period	42
Set-Up for PWM Operation	43
TMR2 to PR2 Match	36, 42
TMR2 to PR2 Match Enable (TMR2IE Bit)	16
TMR2 to PR2 Match Flag (TMR2IF Bit)	17
Q	
Q-Clock	42
R	
RAM. See Data Memory	
Reader Response	104
Register File	10
Register File Map	10
Reset	51, 54
Block Diagram	56

Brown-out Reset (BOR). See Brown-out Reset (BOR)	
MCLR Reset. See MCLR	
Power-on Reset (POR). See Power-on Reset (POR)	
Reset Conditions for All Registers	59
Reset Conditions for PCON Register	58
Reset Conditions for Program Counter	58
Reset Conditions for STATUS Register	58
Timing Diagram	83
WDT Reset. See Watchdog Timer (WDT)	
Revision History	95

S

Sleep	64
Sleep	51, 54
Software Simulator (MPLAB SIM)	70
Special Event Trigger. See Compare	
Special Features of the CPU	51
Special Function Registers	11
Speed, Operating	1
Stack	19
STATUS Register	11, 13, 62
C Bit	13
DC Bit	13
IRP Bit	13
PD Bit	13, 54
RP1:RP0 Bits	13
TO Bit	13, 54
Z Bit	13

T

T1CON Register	11, 31
T1CKPS1:T1CKPS0 Bits	31
T1OSCEN Bit	31
T1SYNC Bit	31
TMR1CS Bit. See TMR1CS	31
TMR1ON Bit	31
T2CON Register	11, 36
T2CKPS1:T2CKPS0 Bits	36
TMR2ON Bit	36
TOUTPS3:TOUTPS0 Bits	36
Timer0	29
Block Diagram	29
Clock Source Edge Select (T0SE Bit)	14, 29
Clock Source Select (T0CS Bit)	14, 29
Overflow Enable (T0IE Bit)	15
Overflow Flag (T0IF Bit)	15, 62
Overflow Interrupt	30, 62
Prescaler. See Prescaler, Timer0	
Timing Diagram	84
TMR0 Register	11
Timer1	31
Block Diagram	32
Capacitor Selection	34
Clock Source Select (TMR1CS Bit)	31
External Clock Input Sync (T1SYNC Bit)	31
Module On/Off (TMR1ON Bit)	31
Oscillator	31, 34
Oscillator Enable (T1OSCEN Bit)	31
Overflow Enable (TMR1IE Bit)	16
Overflow Flag (TMR1IF Bit)	17
Overflow Interrupt	31, 34
Prescaler. See Prescaler, Timer1	
Special Event Trigger (CCP)	34, 41
T1CON Register	11, 31
Timing Diagram	84
TMR1H Register	11, 31